

Parker Chomerics CHO-BOND 1026 Conductive Silicone Splicing Compound

Category : Polymer , Adhesive , Thermoset

Material Notes:

Conductive splicing compounds are intended for making "custom" EMI/RFI gaskets from standard CHO-SEAL® and CHO-SIL® strips.

Compounds consist of Chomerics silver-bearing powders dispersed in silicone binder. Information provided by Chomerics

Order this product through the following link:

http://www.lookpolymers.com/polymer_Parker-Chomerics-CHO-BOND-1026-Conductive-Silicone-Splicing-Compound.php

Physical Properties	Metric	English	Comments
Density	3.10 g/cc	0.112 lb/in ³	

Thermal Properties	Metric	English	Comments
Maximum Service Temperature, Air	200 °C	392 °F	
Minimum Service Temperature, Air	-55.0 °C	-67.0 °F	

Processing Properties	Metric	English	Comments
Pot Life	30 min	30 min	
	@Temperature 24.0 °C	@Temperature 75.2 °F	
Shelf Life	20160 min	20160 min	
	@Temperature -35.0 °C	@Temperature -31.0 °F	
Shelf Life	6.00 Month	6.00 Month	For parts A & B

Descriptive Properties	Value	Comments
Part A/B/C %	100/2.5	

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